

SCH1304-TL-E-VB Datasheet P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.) (nC)			
	0.450 at V _{GS} = -4.5 V	-0.55				
-20	0.500 at V _{GS} = -2.5 V	-0.50	1			
	0.600 at V _{GS} = -1.8 V	-0.38				

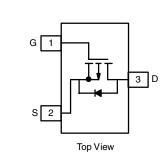
FEATURES

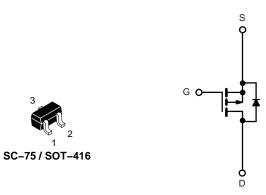
- Trench power MOSFET
- 100 % R tested
- Fast switching speed



APPLICATIONS

- Load / power switch for portable devices
- Drivers: relays, solenoids, displays
- Battery operated systems





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-20	V	
Gate-Source Voltage		V _{GS}	± 12	V	
Ocalis as Paris Ocasal (T., 450.00)	T _A = 25 °C		-0.55 ^{b, c}		
Continuous Drain Current (T _J = 150 °C)	T _A = 70 °C	I _D	-0.45 ^{b, c}	A	
Pulsed Drain Current (t = 300 μs)		I _{DM}	-1.8	A	
Continuous Source-Drain Diode Current	T _A = 25 °C	Is	-0.16 ^{b, c}		
Maximum Bayer Dissipation	T _A = 25 °C	В	0.19 ^{b, c}	w	
Maximum Power Dissipation	T _A = 70 °C	P _D	0.12 ^{b, c}	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stq}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 5 s	R_{thJA}	440	530	°C/W	
iviaximum sunction-to-ambient 4, 2	Steady State		540	650		

Notes

- a. Maximum under steady state conditions is 650 $^{\circ}\text{C/W}.$
- b. Surface mounted on 1" x 1" FR4 board.
- $c. \ t=5 \ s.$

服务热线:400-655-8788

1



PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$, $I_D = -250 \mu A$	-20	_	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-12	-	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	1.8	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-	-1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 30		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 1		
Zoro Goto Voltago Drain Current	l	V _{DS} = -20 V, V _{GS} = 0 V	-	-	-1	— μA —	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 85 °C	-	-	-10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-1.5	-	-	Α	
		V _{GS} = -4.5 V, I _D = -0.4 A	-	0.450	-	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -0.2 \text{ A}$	-	0.500	-		
		$V_{GS} = -1.8 \text{ V}, I_D = -0.1 \text{ A}$	-	0.600	-		
Forward Transconductance	9fs	$V_{DS} = -10 \text{ V}, I_D = 0.4 \text{ A}$	-	1	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	45	-	pF	
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	15	-		
Reverse Transfer Capacitance	C _{rss}		-	10	ı		
Total Gata Chargo	Qg	$V_{DS} =$ -10 V, $V_{GS} =$ -4.5 V, $I_D =$ -0.4 A	-	1.65	2.50		
Total Gate Charge			-	1	2	nC	
Gate-Source Charge	Q_{gs}	V_{DS} = -0 V, V_{GS} = -2.5 V, I_D = -0.4	-	0.2	ı	110	
Gate-Drain Charge	Q_{gd}		-	0.26	ı		
Gate Resistance	R_g	f = 1 MHz	2.4	12	24	Ω	
Turn-On Delay Time	t _{d(on)}		-	9	18		
Rise Time	t _r	V_{DD} = -10 V, R_L = 33.3 Ω	-	10	20		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -0.3 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 Ω	-	10	20		
Fall Time	t _f		-	8	16	ns	
Turn-On Delay Time	t _{d(on)}		-	1	2	113	
Rise Time	t _r	V_{DD} = -10 V, R_L = 33.3 Ω	-	8	16		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -0.3 A, $V_{GEN}=$ -8 V, $R_g=$ 1 Ω	-	9	18		
Fall Time	t _f		-	5	10		
Drain-Source Body Diode Characteris	tics						
Pulse Diode Forward Current ^a	I _{SM}		-	_	-1.5	Α	
Body Diode Voltage	V_{SD}	I _S = -0.3 A	-	-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	16	24	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 0.3 A dl/d+ = 100 A/vo	-	8	16	nC	
Reverse Recovery Fall Time	ta	I _F = -0.3 A, dl/dt = 100 A/μs		11	-		
everse Recovery Rise Time t _b		_	5	-	ns		

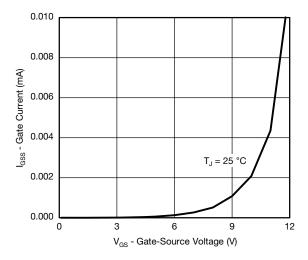
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

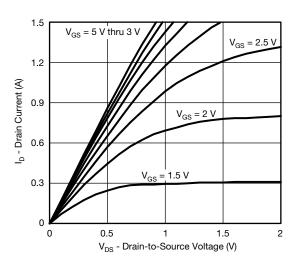
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



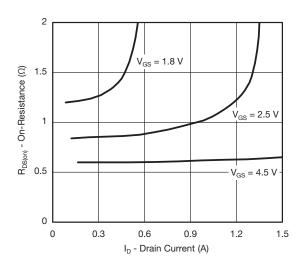
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



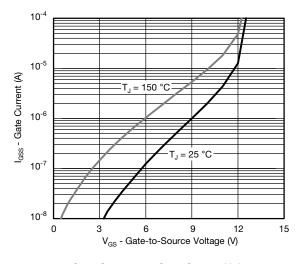
Gate Current vs. Gate-Source Voltage



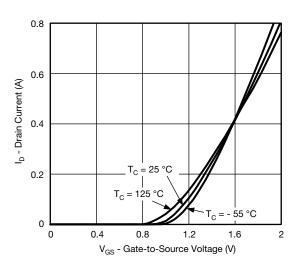
Output Characteristics



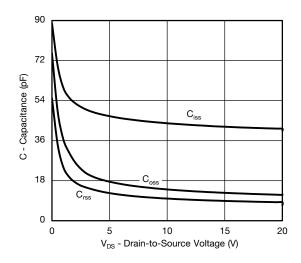
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



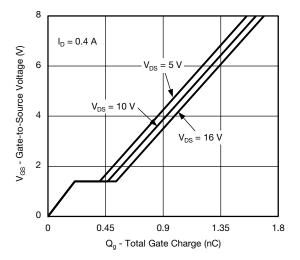
Transfer Characteristics



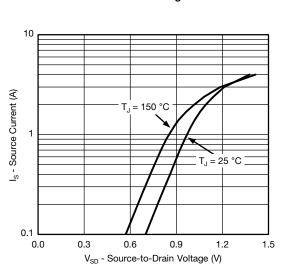
Capacitance



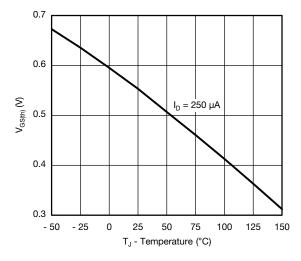
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



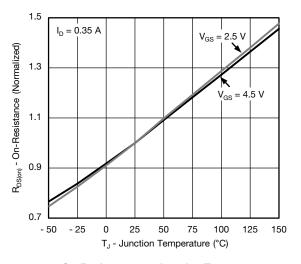
Gate Charge



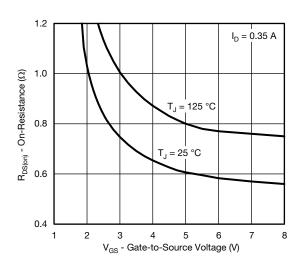
Source-Drain Diode Forward Voltage



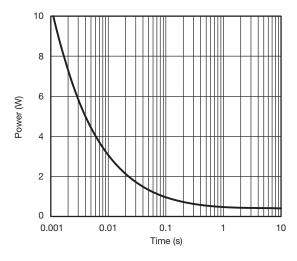
Threshold Voltage



On-Resistance vs. Junction Temperature



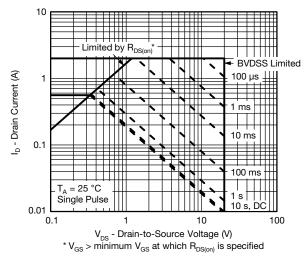
On-Resistance vs. Gate-to-Source Voltage

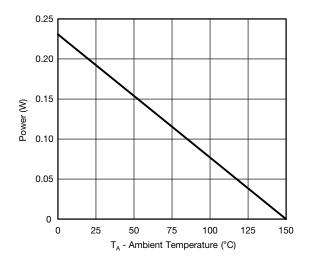


Single Pulse Power, Junction-to-Ambient



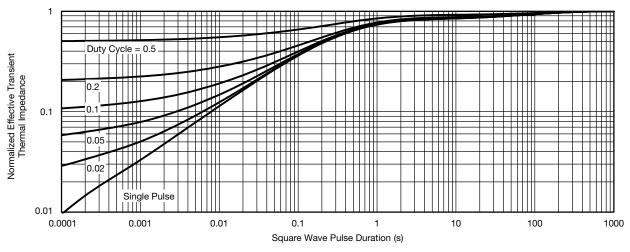
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Safe Operating Area, Junction-to-Ambient

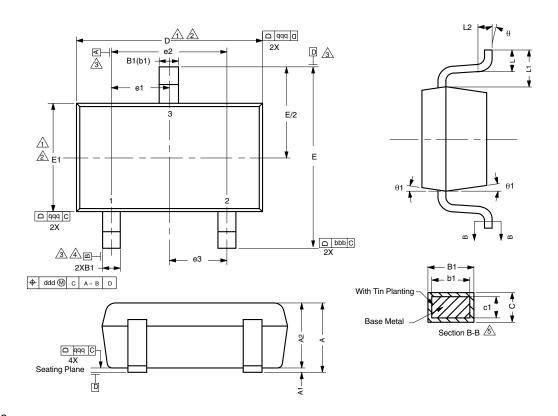
Power Derating, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



SC-75: 3 Leads



DWG: 5868

Notes

Dimensions in millimeters will govern.

⚠Dimension D does not include mold flash, protrusions or gate burrs. Mold flash protrusions or gate burrs shall not exceed 0.10 mm per end. Dimension E1 does not include Interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.10 mm per side.

Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

Datums A, B and D to be determined 0.10 mm from the lead tip.

Terminal positions are shown for reference only.

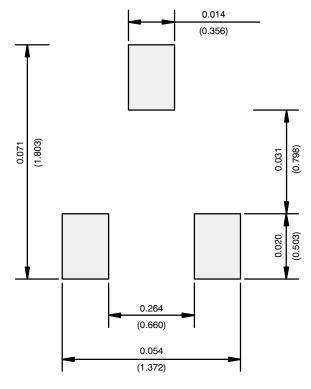
These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIMENSIONS	TOLERANCES
aaa	0.10
bbb	0.10
ccc	0.10
ddd	0.10

DIM.	N	NOTE		
DIIVI.	MIN.	NOM.	MAX.	NOTE
А	-	-	0.80	
A1	0.00	-	0.10	
A2	0.65	0.70	0.80	
B1	0.19	-	0.24	5
b1	0.17	0.17 - 0.21		
С	0.13	-	0.15	5
c1	0.10	-	0.12	5
D	1.48	1.575	1.68	1, 2
Е	1.50	1.60	1.70	
E1	0.66	0.76	0.86	1, 2
e1	0.50 BSC			
e2	1.00 BSC			
e3	0.50 BSC			
L	0.15	0.205	0.30	
L1	0.40 ref.			
L2	0.15 BSC			
q	0°	- 8°		
q1	4°	-	10°	



RECOMMENDED MINIMUM PADS FOR SC-75: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

服务热线:400-655-8788 7



Disclaimer

All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

Taiwan VBsemi Electronics Co., Ltd., branches, agents, employees, and all persons acting on its or their representatives (collectively, the "Taiwan VBsemi"), assumes no responsibility for any errors, inaccuracies or incomplete data contained in the table or any other any disclosure of any information related to the product.(www.VBsemi.com)

Taiwan VBsemi makes no guarantee, representation or warranty on the product for any particular purpose of any goods or continuous production. To the maximum extent permitted by applicable law on Taiwan VBsemi relinquished: (1) any application and all liability arising out of or use of any products; (2) any and all liability, including but not limited to special, consequential damages or incidental; (3) any and all implied warranties, including a particular purpose, non-infringement and merchantability guarantee.

Statement on certain types of applications are based on knowledge of the product is often used in a typical application of the general product VBsemi Taiwan demand that the Taiwan VBsemi of. Statement on whether the product is suitable for a particular application is non-binding. It is the customer's responsibility to verify specific product features in the products described in the specification is appropriate for use in a particular application. Parameter data sheets and technical specifications can be provided may vary depending on the application and performance over time. All operating parameters, including typical parameters must be made by customer's technical experts validated for each customer application. Product specifications do not expand or modify Taiwan VBsemi purchasing terms and conditions, including but not limited to warranty herein.

Unless expressly stated in writing, Taiwan VBsemi products are not intended for use in medical, life saving, or life sustaining applications or any other application. Wherein VBsemi product failure could lead to personal injury or death, use or sale of products used in Taiwan VBsemi such applications using client did not express their own risk. Contact your authorized Taiwan VBsemi people who are related to product design applications and other terms and conditions in writing.

The information provided in this document and the company's products without a license, express or implied, by estoppel or otherwise, to any intellectual property rights granted to the VBsemi act or document. Product names and trademarks referred to herein are trademarks of their respective representatives will be all.

Material Category Policy

Taiwan VBsemi Electronics Co., Ltd., hereby certify that all of the products are determined to be oHS compliant and meets the definition of restrictions under Directive of the European Parliament 2011/65 / EU, 2011 Nian. 6. 8 Ri Yue restrict the use of certain hazardous substances in electrical and electronic equipment (EEE) - modification, unless otherwise specified as inconsistent.(www.VBsemi.com)

Please note that some documents may still refer to Taiwan VBsemi RoHS Directive 2002/95 / EC. We confirm that all products identified as consistent with the Directive 2002/95 / EC European Directive 2011/65 /.

Taiwan VBsemi Electronics Co., Ltd. hereby certify that all of its products comply identified as halogen-free halogen-free standards required by the JEDEC JS709A. Please note that some Taiwanese VBsemi documents still refer to the definition of IEC 61249-2-21, and we are sure that all products conform to confirm compliance with IEC 61249-2-21 standard level JS709A.